

DEK Pro and DEK Pro XF

ADVANCED UNDERSTENCIL CLEANING CHEMISTRIES



Designed specifically for understencil cleaning, DEK Pro and DEK Pro XF improve process performance and reduce print defects.

They are safer, cleaner and more environmentally friendly than IPA and traditional solvent cleaners and are compliant with all industry standards and environmental regulations.

Dek nan

Health, Safety and the Environment

- DEK Pro XF has no flash point
- DEK Pro has a high flash point of 67°C (IPA 12° C)
- Safer to use, transport, store and dispose of
- Manufactured using biodegradable materials
- DEK Pro XF is low VOC

Reduce Print Defects

- No impact on thixotropic properties of the solder paste
- Reduce risk of solder slump and solder balling
- Residue-free after evaporation

Compliant and Compatible

- Compatible with all Solder Paste Materials
- RoHs and Reach compliant

DEK Pro and DEK Pro XF UNDERSTENCIL CLEANING AGENTS

| DEK PRO TECHNICAL SPECIFICATIONS | | | |
|----------------------------------|-------------------------|--|--|
| Property | Value | | |
| Formulation | Solvent Based | | |
| Application | Pure (not diluted) | | |
| Flash Point | 67°C | | |
| Vapour Pressure | 3 mbar @ 20°C | | |
| Boiling Range | 100 – 170°C | | |
| pH Value | Neutral | | |
| HMIS Rating | | | |
| Health – | 1 – 2 - 0 | | |
| Flammability – | | | |
| Reactivity | | | |
| Working Temperature | Workroom Temperature | | |
| Storage and Transport | No Special Requirements | | |
| | | | |

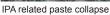
| DEK PRO XF TECHNICAL SPECIFICATIONS | | | |
|-------------------------------------|-------------------------|--|--|
| Property | Value | | |
| Formulation | Water Based | | |
| Application | Pure (not diluted) | | |
| Flash Point | None | | |
| Vapour Pressure | 20 mbar @ 20°C | | |
| Boiling Range | 80 – 200°C | | |
| pH Value | Neutral | | |
| HMIS Rating | | | |
| Health – | 0 – 0 - 0 | | |
| Flammability – | | | |
| Reactivity | | | |
| Working Temperature | Workroom Temperature | | |
| Storage and Transport | No Special Requirements | | |

| DEK PRO PRODUCT RANGE | | | | |
|-----------------------|------------------------|-----------|--|--|
| Part number | Description | Volume | Available for | |
| 173483 | DEK Pro Cleaning Agent | 1 litre | Vacuum and Non Vacuum Printers and Manual Cleaning | |
| 173485 | DEK Pro Cleaning Agent | 5 litres | Vacuum and Non Vacuum Printers and Manual Cleaning | |
| 431093 | DEK Pro Cleaning Agent | 20 litres | Vacuum and Non Vacuum Printers and Manual Cleaning | |

| DEK PRO XF PRODUCT RANGE | | | | |
|--------------------------|---------------------------|----------|-----------------|--|
| Part number | Description | Volume | Available for | |
| 431513 | DEK Pro XF Cleaning Agent | 1 litre | Vacuum Printers | |
| 431514 | DEK Pro XF Cleaning Agent | 5 litres | Vacuum Printers | |

Using IPA in screen printers can cause defects! Chemistry effect on solder paste printed on copper substrate wet with cleaning agent







DEK Pro XF



Effective and thorough cleaning agents that clean without affecting solder paste flux chemistry







Compatible with all solder pastes – leaded and lead-free

Americas:

ASM Assembly Systems USA Inc.

Tel +847 368 1155

Email: ussales@asmpt.com

Europe:

ASM Assembly Systems Northern Europe

Tel +44 (0) 1305 208328 Email: sales@asmpt.com Δsia

ASM Assembly Systems Singapore PTE LTD Tel +65 6419 5867

Email: asiaspares@asmpt.com

www.dek.com